November 20, 2026

93rd Issuance of Domestic Unsecured Straight Bonds

ACOM CO., LTD. has reached a decision to make its 93rd issuance of domestic unsecured straight bonds, as outlined below. The funds procured through this issuance will be used for redemption of bond.

Name of issuance	ACOM CO., LTD. 93rd issuance of domestic unsecured straight bonds
Total value	13 billion yen
Interest rate	2.401% annually
Individual bond value	100 million yen
Issue price	Face value 100 yen
Redemption price	Face value 100 yen
Application period	November 20, 2026
Payment date	November 27, 2026
Maturation date	May 25, 2029
Application of funds procured	Redemption of bond
Trustee	Mitsubishi UFJ Morgan Stanley Securities Co., Ltd. SMBC Nikko Securities Inc. Daiwa Securities Co. Ltd. Nomura Securities Co., Ltd. Shinkin Securities Co., Ltd.
Transfer agent	MUFG Bank, Ltd.
Credit ratings	Rating and Investment Information, Inc.: AA-

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